

## **Description**

The IRFR024NT uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



### TO252-2L

### **General Features**

 $V_{DS} = 60V I_{D} = 30 A$ 

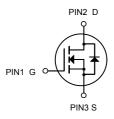
 $R_{DS(ON)}$  < 26m $\Omega$  @  $V_{GS}$ =10V

### **Application**

Battery protection

Load switch

Uninterruptible power supply



N-Channel MOSFET

# **Package Marking and Ordering Information**

	<u> </u>		
Product ID	Pack	Marking	Qty(PCS)
IRFR024NT	TO252-2L	30N06XXXX YYYY	2500

# Absolute Maximum Ratings (T<sub>C</sub>=25°Cunless otherwise noted)

Symbol	Parameter Rating		Units	
V <sub>D</sub> s	Drain-Source Voltage	60		
Vgs	Gate-Source Voltage	Gate-Source Voltage ±20		
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	tinuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> 30		
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	) 10V <sup>1</sup> 15		
I <sub>D</sub> @T <sub>A</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> 5.6		
ID@Ta=70°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	uous Drain Current, V <sub>GS</sub> @ 10V¹ 4.5		
Ідм	Pulsed Drain Current <sup>2</sup>	46	А	
EAS	Single Pulse Avalanche Energy <sup>3</sup>	e Pulse Avalanche Energy³ 25.5		
las	Avalanche Current	22.6	А	
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	34.7	W	
P <sub>D</sub> @T <sub>A</sub> =25°C	25°C Total Power Dissipation <sup>4</sup> 2		W	
Тѕтс	Tste Storage Temperature Range		°C	
TJ	T <sub>J</sub> Operating Junction Temperature Range -55 to 150		°C	



ReJA	Thermal Resistance Junction-Ambient <sup>1</sup>	62	°C/W
Rejc	Thermal Resistance Junction-Case <sup>1</sup>	3.6	°C/W

# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

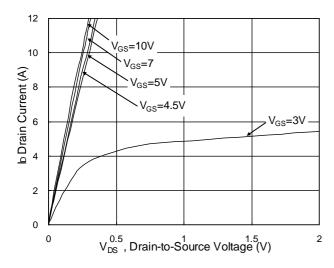
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BVpss	Drain-Source Breakdown Voltage V <sub>GS</sub> =0V , I <sub>D</sub> =250uA		60			V
△BVbss/△TJ	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.063		V/°C
_		V <sub>GS</sub> =10V , I <sub>D</sub> =15A		22	26	
Rds(on)	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =10A		30	38	mΩ
VGS(th)	Gate Threshold Voltage	V V 1 050 A	1.2		2.5	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=250uA$		-5.24		mV/°C
		V <sub>DS</sub> =48V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	
IDSS	Drain-Source Leakage Current	V <sub>DS</sub> =48V , V <sub>GS</sub> =0V , T <sub>J</sub> =55°C			5	uA
Igss	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20V$ , $V_{DS}$ = $0V$			±100	nA
gfs	Forward Transconductance	$V_{DS}$ =5 $V$ , $I_{D}$ =15 $A$		17		S
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		3.2		Ω
Qg	Total Gate Charge (4.5V)			12.6		
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =48V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =12A		3.2		nC
$Q_{gd}$	Gate-Drain Charge			6.3		
Td(on)	Turn-On Delay Time			8		
Tr	Rise Time	V <sub>DD</sub> =30V , V <sub>GS</sub> =10V ,		14.2		
Td(off)	Turn-Off Delay Time	—R <sub>G</sub> =3.3 , I <sub>D</sub> =10A		24.4		ns
T <sub>f</sub>	Fall Time	_ID-TOA		4.6		
Ciss	Input Capacitance			1378		
Coss	Output Capacitance	── V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		86		pF
Crss	Reverse Transfer Capacitance	7		64		
ls	Continuous Source Current <sup>1,5</sup>				23	Α
Іѕм	Pulsed Source Current <sup>2,5</sup>	─V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			46	Α
VsD	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V

### Note:

- 1.The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%
- 3.The EAS data shows Max. rating . The test condition is VDD=25V,VGS=10V,L=0.1mH,IAS=22.6A
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.



## **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

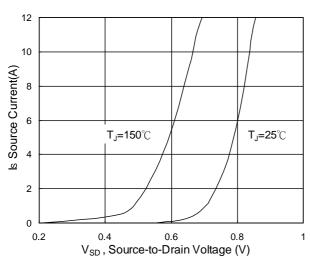


Fig.3 Forward Characteristics of Reverse

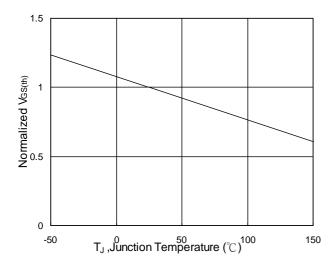


Fig.5 Normalized  $V_{GS(th)}$  v.s  $T_J$ 

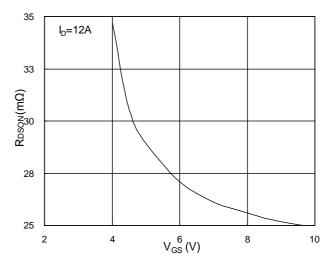


Fig.2 On-Resistance v.s Gate-Source

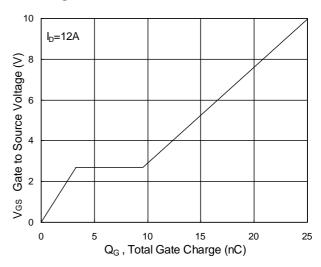


Fig.4 Gate-Charge Characteristics

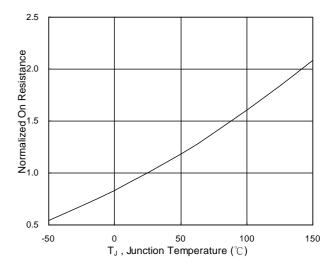
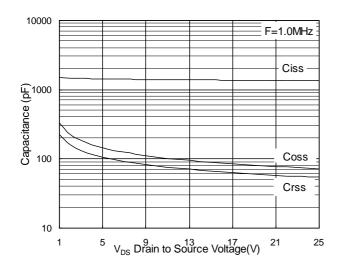


Fig.6 Normalized R<sub>DSON</sub> v.s T<sub>J</sub>





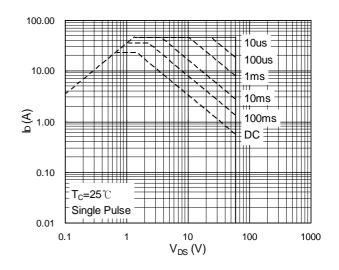


Fig.7 Capacitance

Fig.8 Safe Operating Area

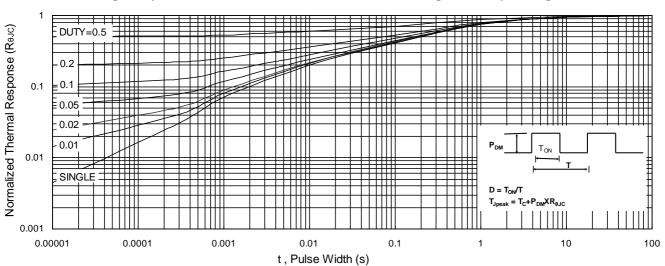


Fig.9 Normalized Maximum Transient Thermal Impedance

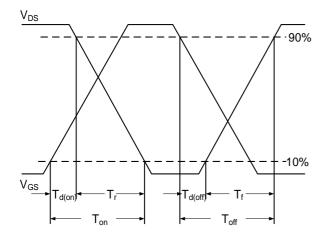


Fig.10 Switching Time Waveform

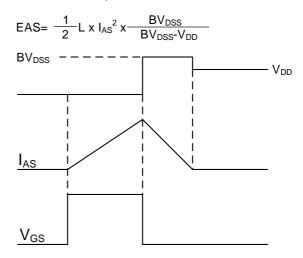
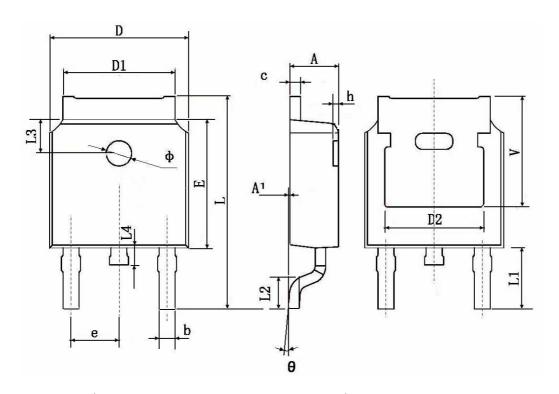


Fig.11 Unclamped Inductive Waveform



# **TO252-2L Package Information**



O. waland	Dimensions In Millimeters		Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
Α	2.200	2.400	0.087	0.094		
A1	0.000	0.127	0.000	0.005		
b	0.660	0.860	0.026	0.034		
С	0.460	0.580	0.018	0.023		
D	6.500	6.700	0.256	0.264		
D1	5.100	5.460	0.201	0.215		
D2	0.483	TYP.	0.190	TYP.		
E	6.000	6.200	0.236	0.244		
е	2.186	2.386	0.086	0.094		
L	9.800	10.400	0.386	0.409		
L1	2.900	TYP.	0.114	0.114 TYP.		
L2	1.400	1.700	0.055	0.067		
L3	1.600	TYP.	0.063	TYP.		
L4	0.600	1.000	0.024	0.039		
Ф	1.100	1.300	0.043	0.051		
θ	0°	8°	0°	8°		
h	0.000	0.300	0.000	0.012		
V	5.350	) TYP.	0.211	11 TYP.		

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